## Electronic Acknowledgement Receipt FES ID: 1091085 Application Number: 10829060 Confirmation Number: 7493 Title of Invention: Bonding structure with buffer layer and method of forming the same First Named Inventor: Su-Tsai Lu Customer Number: 33804 Filer: Jason Zse-Cherng Lin Filer Authorized By: Attorney Docket Number: 04146-UPL Receipt Date: 24-JUN-2006 Filing Date: 20-APR-2004 Time Stamp: 11:34:05 Application Type: Utility International Application Number: Payment information:

## File Listing:

Submitted with Payment

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1	Response to Election / Restriction Filed	04146-URL-Election.pdf	179378	no	1

no

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## New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

## National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/IDO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filling Receipt, in due course.